

## EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
S45	137	((copper nickel solder) near10 plating ) and (novolak or novalak or novolac or novolak or (phenol cresol) same (aldehyde formaldehyde)) and (polyacrylate polyacrylic polymethacrylic polyacrylate) and positiv\$10	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/01/17 13:16
S46	6276	(novolak or novalak or novolac or novolak or (phenol cresol) same (aldehyde formaldehyde)) same (acrylic methacrylic) adj (acid)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/01/17 13:18
S47	1773	(novolak or novalak or novolac or novolak or (phenol cresol) same (aldehyde formaldehyde)) same (acrylic methacrylic) adj (acid) and positiv\$10	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/01/17 13:19
S49	1290	(novolak or novalak or novolac or novolak or (phenol cresol) same (aldehyde formaldehyde)) same (acrylic methacrylic) adj (acid) and positiv\$10 and (plating plated plates)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/01/17 13:21
S48	1290	(novolak or novalak or novolac or novolak or (phenol cresol) same (aldehyde formaldehyde)) same (acrylic methacrylic) adj (acid) and positiv\$10 and (plating plated plate plates)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/01/17 13:21
S51	1016	(novolak or novalak or novolac or novolak or (phenol cresol) same (aldehyde formaldehyde)) with (acrylic methacrylic) adj (acid) and positiv\$10	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/01/17 13:23
S50	229	(novolak or novalak or novolac or novolak or (phenol cresol) same (aldehyde formaldehyde)) same (acrylic methacrylic) adj (acid) and positiv\$10 and (plating plated )	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/01/17 13:23
L1	279	electrolytic adj gold adj plating and (nickel solder copper)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/01/22 11:43
L2	98	electrolytic adj gold adj plating and (nickel solder copper) and photoresist	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/01/22 11:44

## EAST Search History

L4	18	electrolytic adj gold adj plating same (nickel solder copper) and photoresist and positiv\$	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/01/22 11:46
L3	60	electrolytic adj gold adj plating same (nickel solder copper) and photoresist	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/01/22 11:46